INTEGRATED CIRCUITS

DATA SHEET



74LV377

Octal D-type flip-flop with data enable; positive edge-trigger

Product specification Supersedes data of 1997 Mar 04 IC24 Data Handbook





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74LV377

FEATURES

- Optimized for Low Voltage applications: 1.0 to 3.6V
- Accepts TTL input levels between V_{CC} = 2.7V and V_{CC} = 3.6V
- Typical V_{OLP} (output ground bounce) < 0.8V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2V @ V_{CC} = 3.3V, $T_{amb} = 25^{\circ}C$
- Ideal for addressable register applications
- Data enable for address and data synchronization applications
- Eight positive-edge triggered D-type flip-flops
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV377 is a low-voltage CMOS device and is pin and function compatible with 74HC/HCT377.

The 74LV377 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. A common clock (CP) input loads all flip-flops simultaneously when the data enable (\overline{E}) is LOW. The state of each D input, one set-up time before the LOW-to-HIGH clock transition, is transferred to the corresponding output (Qn) of the flip-flop. The \overline{E} input must be stable only one set-up time prior to the LOW-to-HIGH transition for predictable operation.

QUICK REFERENCE DATA

QUICK REFER GND = 0V; T _{amb} = 2	ENCE DATA 25°C ; $t_r = t_f \le 2.5 \text{ ns}$	4. 4. 元		
SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay CP to Q _n	C _L = 15pF	13	ns
f _{max}	Maximum clock frequency	$V_{CC} = 3.3V$	77	MHz
C _I	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per flip-flop	Notes 1 and 2	20	pF

NOTES:

- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_0)$ where: f_i = input frequency in MHz; C_L = output load capacity in pF; f_0 = output frequency in MHz; V_{CC} = supply voltage in V; $\Sigma (C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

 2. The condition is V_I = GND to V_{CC}

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic DIL	-40°C to +125°C	74LV377 N	74LV377 N	SOT146-1
20-Pin Plastic SO	-40°C to +125°C	74LV377 D	74LV377 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to +125°C	74LV377 DB	74LV377 DB	SOT339-1
20-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV377 PW	74LV377PW DH	SOT360-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	Ē	Data enable input (active-LOW)
2, 5, 6, 9, 12, 15, 16, 19	Q ₀ to Q ₇	flip-flop outputs
3, 4, 7, 8, 13, 14, 17, 18	D ₀ to D ₇	Data inputs
10	GND	Ground (0V)
11	СР	Clock input (LOW-to-HIGH, edge-triggered)
20	V _{CC}	Positive supply voltage

FUNCTION TABLE

OPERATING MODES		NPUTS	;	OUTPUTS
OPERATING WIODES	СР	Ē	D _n	Q _n
Load "1"	1	I	h	Н
Load "0"	1	I	I	L
Hold (do nothing)	↑ X	h H	X X	No change No change

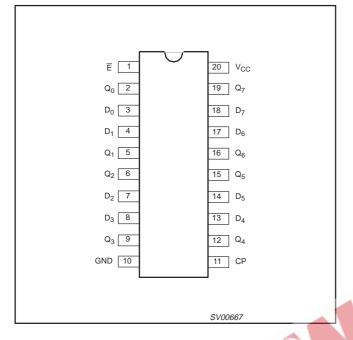
- = HIGH voltage level Н
 - HIGH voltage level one set-up time prior to the LOW-to-HIĞH CP transition
- L = LOW voltage level
- LOW voltage level one set-up time prior to the
 - LOW-to-HIGH CP transition
 - LOW-to-HIGH CP transition
- = Don't care

h

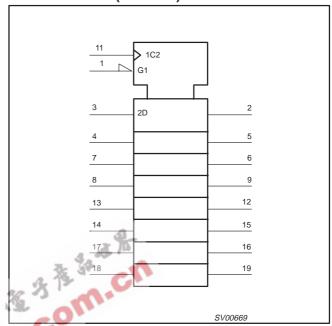
Octal D-type flip-flop with data enable; positive edge-trigger

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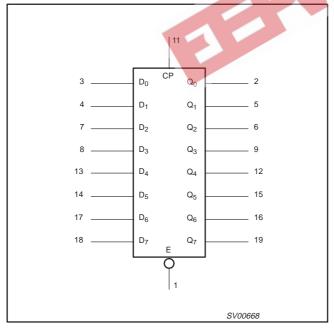
PIN CONFIGURATION



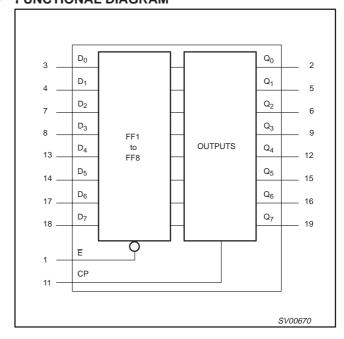
LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



FUNCTIONAL DIAGRAM



Octal D-type flip-flop with data enable; positive edge-trigger

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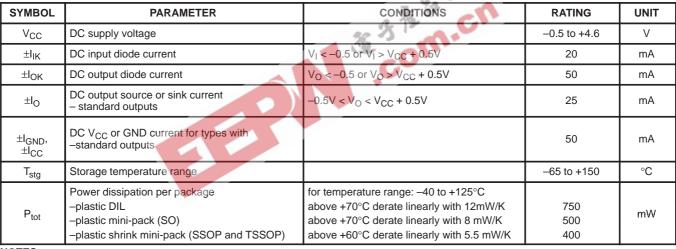
RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	3.6	V
VI	Input voltage		0	_	V _{CC}	V
Vo	Output voltage		0	_	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	V _{CC} = 1.0V to 2.0V V _{CC} = 2.0V to 2.7V V _{CC} = 2.7V to 3.6V	- - -	- - - -	500 200 100	ns/V

NOTE:

ABSOLUTE MAXIMUM RATINGS1, 2

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).



NOTES:

^{1.} The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 3.6V.

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	0°C to +8	5°C	-40°C to	+125°C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	1
		V _{CC} = 1.2V	0.9			0.9		
V_{IH}	HIGH level Input voltage	V _{CC} = 2.0V	1.4			1.4		V
	lg.	V _{CC} = 2.7 to 3.6V	2.0			2.0]
		V _{CC} = 1.2V			0.3		0.3	
V_{IL}	LOW level Input voltage	V _{CC} = 2.0V			0.6		0.6	V
		V _{CC} = 2.7 to 3.6V			0.8		0.8]
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$		1.2				
	HIGH level output	$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	1.8	2.0		1.8]
	voltage; all outputs	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.5	2.7		2.5]
V_{OH}		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.8	3.0	500	2.8		V
	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 6mA$	2.40	2.82	,n	2.20		
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$	-0	0				
	LOW level output	$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$	0	0	0.2		0.2]
	voltage; all outputs	$V_{CC} = 2.7V$; $V_1 = V_{1H}$ or V_{1L} ; $I_0 = 100\mu A$		0	0.2		0.2]
V_{OL}		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	V
	LOW level output voltage; STANDARD outputs	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 6mA$		0.25	0.40		0.50	
I _I	Input leakage current	$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND			1.0		1.0	μА
Icc	Quiescent supply current; MSI	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		160	μА
Δl _{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7V$ to 3.6V; $V_I = V_{CC} - 0.6V$			500		850	μА

NOTE:
1. All typical values are measured at T_{amb} = 25°C.

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AC CHARACTERISTICS

GND = 0V; t_r = t_f \leq 2.5ns; C_L = 50pF; R_L =1K Ω

	η = 2.οο, ο [ο ο ο ο ο ο ο ο ο ο ο ο ο ο ο ο ο		CONDITION			LIMITS				
SYMBOL	PARAMETER	WAVEFORM	CONDITION	_	40 to +85 °	С	-40 to	+125 °C	UNIT	
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX		
			1.2	_	80	-	_	_		
+ +	Propagation delay	Figure 1	2.0	-	27	51	_	61	ns	
t _{PHL} /t _{PLH}	CP to Q _n	Figure i	2.7	-	20	38	_	45	115	
			3.0 to 3.6	_	15 ²	30	_	36		
			2.0	34	9	-	41	_		
t_{W}	Clock pulse width HIGH or LOW	Figure 2	2.7 25 6 -		30	_	ns			
			3.0 to 3.6	20	5 ²	-	24	_		
			1.2	_	25	-	_	_		
	Set-up time	Figure 2	2.0	22	9	_	26	-	ns	
t _{su}	D _n to CP	Figure 2	2.7	16	6	-	19	-	115	
			3.0 to 3.6	13	5 ²	_	15	-		
			1.2	8 3V	10		_	_		
	Set-up time	Figure 2	2.0	22	4	_	26	_	ns	
t _{su}	E to CP	Figure 2	2.7	16	3	-	19	_	115	
			3.0 to 3.6	13	2 ²	-	15	_		
			1.2	_	-15	-	_	_		
t .	Hold time	Figure 2	2.0	5	- 5	-	5	_	ns	
t _h	D _n to CP	rigule 2	2.7	5	-4	-	5	_	113	
			3.0 to 3.6	5	-3 ²	-	5	_		
			1.2	_	- 5	-	_	_		
+ .	Hold time	Figure 2	2.0	5	-2	-	5	-	ns	
	E to CP	igui e z	2.7	5	-2	_	5	_	115	
			3.0 to 3.6	5	-1 ²	_	5	_		
			2.0	14	40	-	12	_		
f_{max}	Maximum clock pulse frequency	Figure 1	2.7	19	58	-	16	_	MHz	
			3.0 to 3.6	24	70 ²	_	20	-		

NOTES:

1. Unless otherwise stated, all typical values are at T_{amb} = 25°C.

2. Typical value measured at V_{CC} = 3.3V.

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AC WAVEFORMS

 $V_M = 1.5V$ at $V_{CC} \ge 2.7V$

 $V_{M} = 1.5 \text{V}$ at $V_{CC} = 2.7 \text{V}$ $V_{M} = 0.5 \text{V} * V_{CC}$ at $V_{CC} < 2.7 \text{V}$ V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

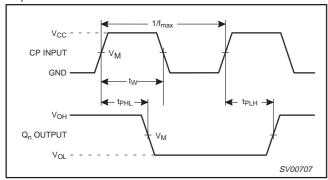


Figure 1. Clock (CP) to output (Q_n) propagation delays, the clock pulse width and the maximum clock pulse frequency.

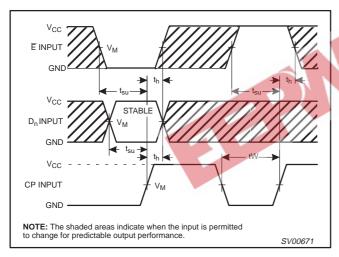
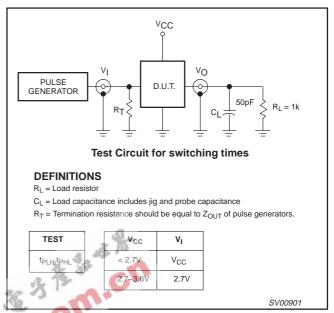


Figure 2. Data set-up and hold times from the data input (Dn) and from the enable input (\overline{E}) to the clock (CP).

TEST CIRCUIT



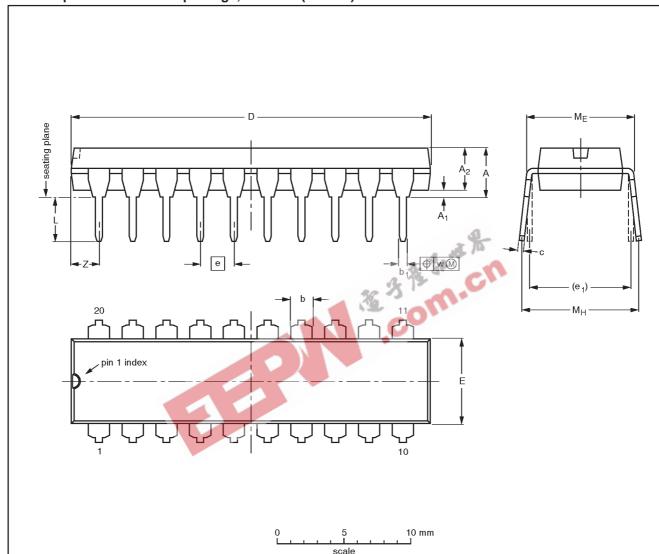
Load circuitry for switching times

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DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

DIMENTOR	•														
UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

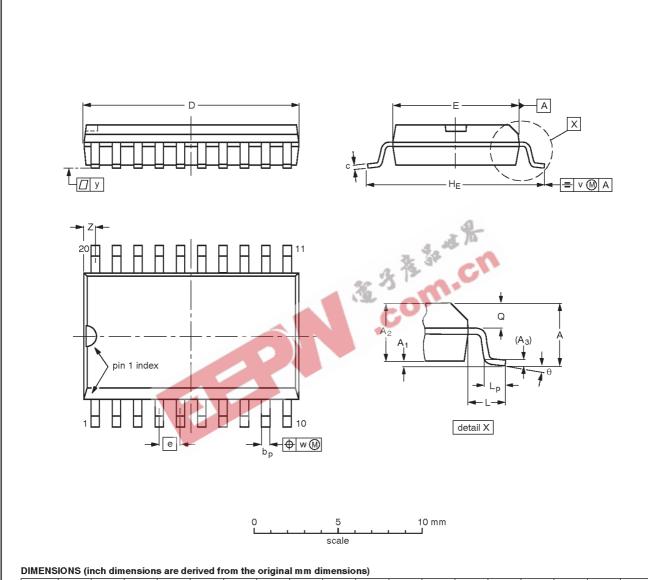
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT146-1			SC603		92-11-17 95-05-24

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

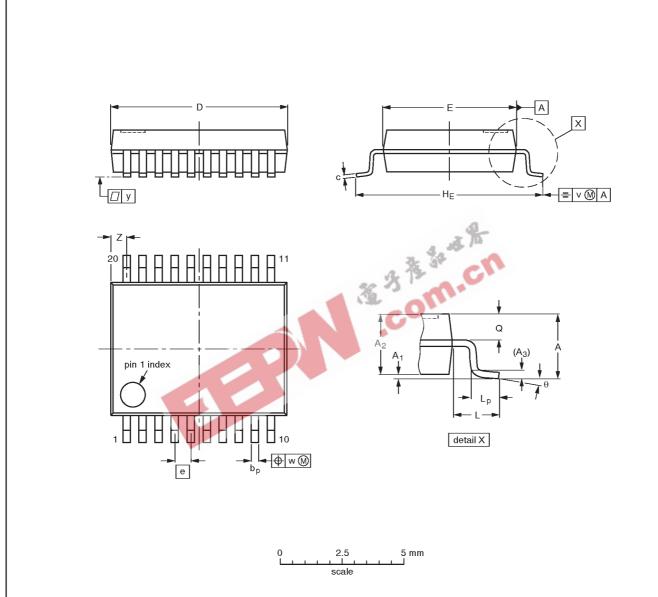
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC				-92-11-17 95-01-24

Octal D-type flip-flop with data enable; positive edge-trigger

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

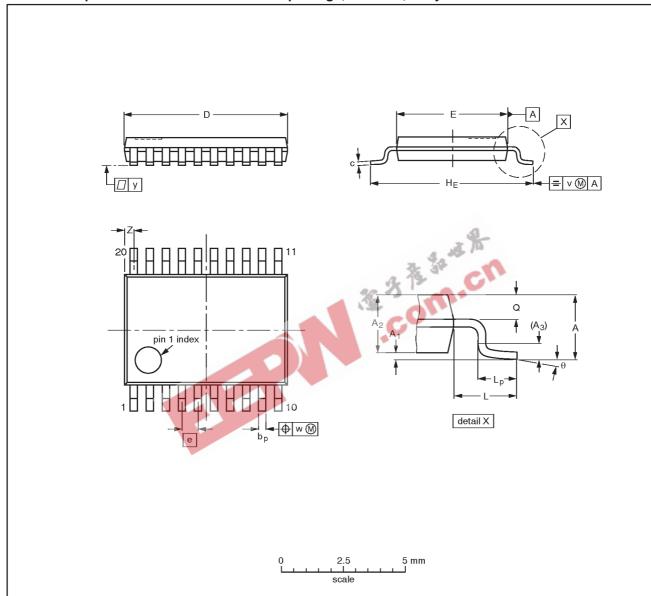
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT339-1		MO-150AE				-93-09-08 95-02-04	

Octal D-type flip-flop with data enable; positive edge-trigger

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bр	c	D (1)	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ICCUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT360-1		MO-153AC				-93-06-16- 95-02-04	

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		DEFINITIONS
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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